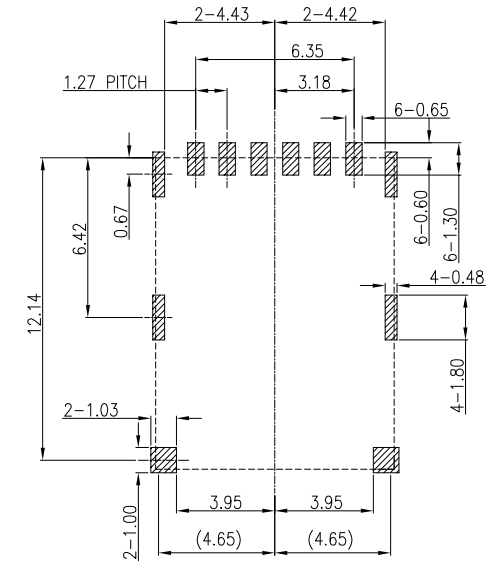
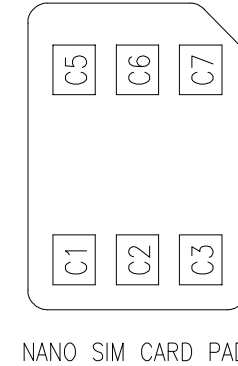
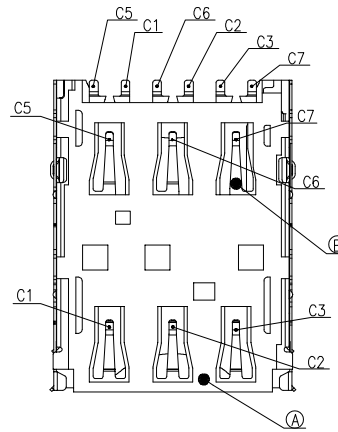
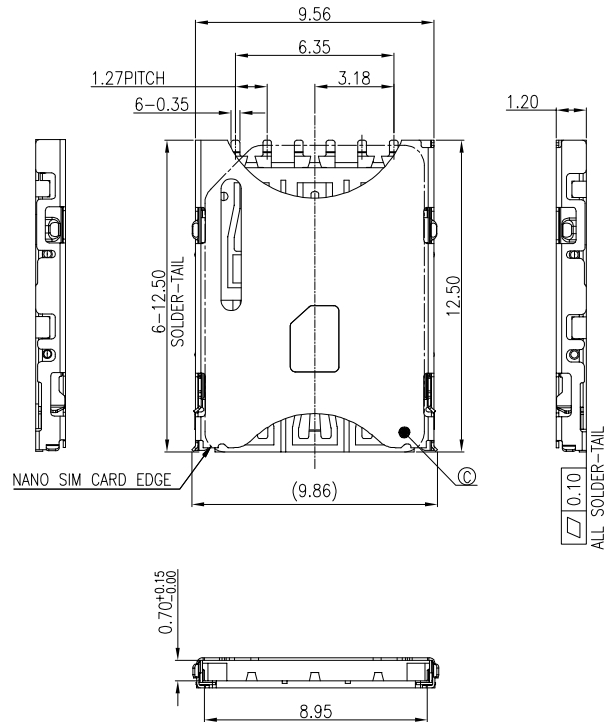


RoHS Compliant

REVISIONS

REV.	DESCRIPTION	DATE	DESIGN



RECOMMENDED P.C.B. LAYOUT
TOLERANCE(TOP VIEW) ±0.05mm

PART NO. INFORMATION

NSIM - 06 X X 5 R - 007

06:6P	PACKAGE
CONTACT PLATED	R: TAPE REEL
1: GOLD FLASH	HOUSING COLOR
2: GOLD 3U"	2: WHITE
3: GOLD 5U"	5: BLACK
4: GOLD 10U"	9: NATURE
5: GOLD 15U"	HOUSING MATERIAL
6: GOLD 30U"	A: LCP B: PBT
	C: PA9T D: PA6T
	E: PA46 F: PA66

SPECIFICATIONS:

- ELECTRICAL CHARACTERISTICS:
 - 1-1. CURRENT RATING:1A
 - 1-2.DIELECTRIC WITHSTANDING VOLTAGE:500V R.M.S MIN;
 - 1-3.INSULATION RESISTANCE:500 MΩ MIN.
 - 1-4.CONTACT RESISTANCE:100mΩ MAX.(INITIAL)
- LIFE TEST: 1500 CYCLES
- FOR REFLOW SOLDERING LEAD-FREE PROCESS.
- PACKAGING: TAPE & REEL.

C	HOUSING	1	STAINLESS STEEL, 0.10T	GOLD FLASH ON SOLDER AREA 50u MIN NICKEL UNDER-PLATED
B	CONTACT	1	COPPER ALLOY, 0.10T	GOLD FLASH ON CONTACT AND SOLDER AREA 50u MIN NICKEL UNDER-PLATED
A	HOUSING	1	HIGH TEMP,THERMOPLASTIC UL 94V-0	BLACK
No.	DESCRIPTION	QTY	MATERIAL	PLATING&COLOR

Bestcreate Technology Limited

TOLERANCES UNLESS OTHERWISE SPECIFIED:

.X	±	0.30	.X"	±	5"
.XX	±	0.20	.X"	±	2"
.XXX	±	0.10	.X"	±	1"

Website:www.bsc-elec.com
Email:bestcreate@bsc-elec.com

DESIGN: I.L
DATE: 2017.3.1

CHECKED: C.W
DATE: 2017.3.1

APPROVED: C.W
DATE: 2017.3.1

TITLE: NANO SIM CARD P/P 6PIN 1.20H

MATERILA:	PART NO:	SIZE:
FINSH:	DWG NO:	1 OF 2